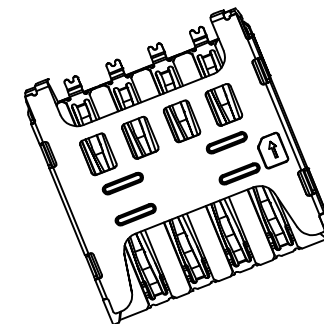
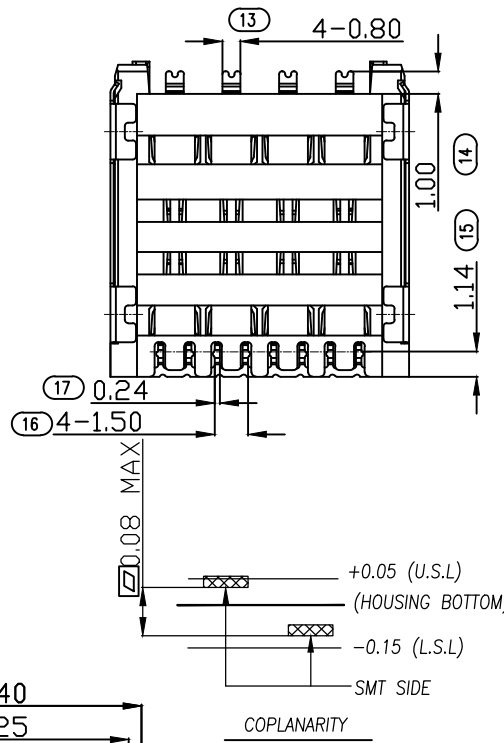
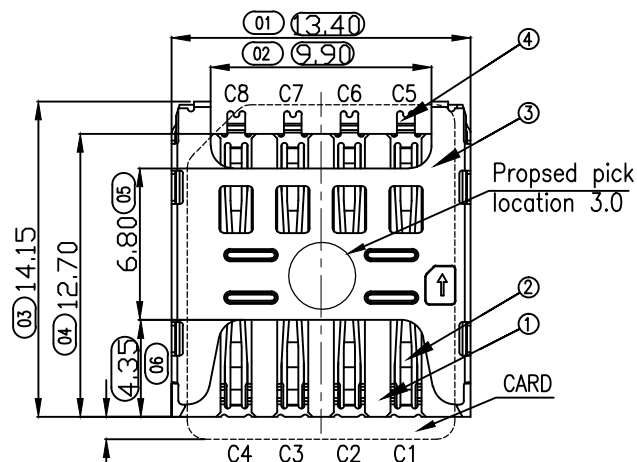


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2014/03/29



NOTES:

1. MATERIAL:SEE TABLE

2.1 Rated current:1.0A

2.2 Rated voltage:30V

2.3 Contact Resistance:50mΩ MAX

2.4 Insulation Resistance:1000MΩ MIN 500V DC

2.5 Dielectric withstanding voltage: 500V DC.

2.6 Solder ability:250℃±5℃, 10s±0.5s.

2.7 Durability:3000 Cycles Min.Contact Resistance50mΩMax

2.8 Mating and Unmating force

Insertion Force 10N Max

Withdrawal Fore 10N Max

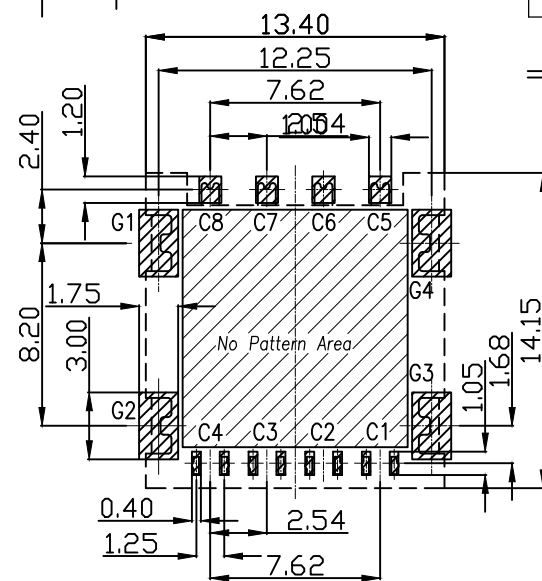
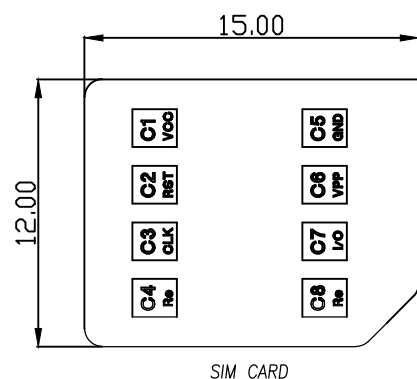
2.9 Noraml Force:30~100g(Noraml card)

Noraml working stroke: 0.3mm Min(Noraml card)

3.0 Operating condition:Temperature-40℃~+85℃;

Humidity 80% R.H MAX

3. PLEASE CONTACT JITS SALES REPRESENTATIVE TO
VERIFY PRODUCT DETAILS & AVAILABILITY

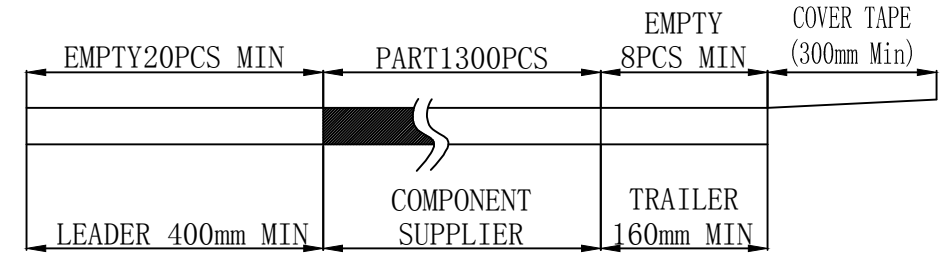
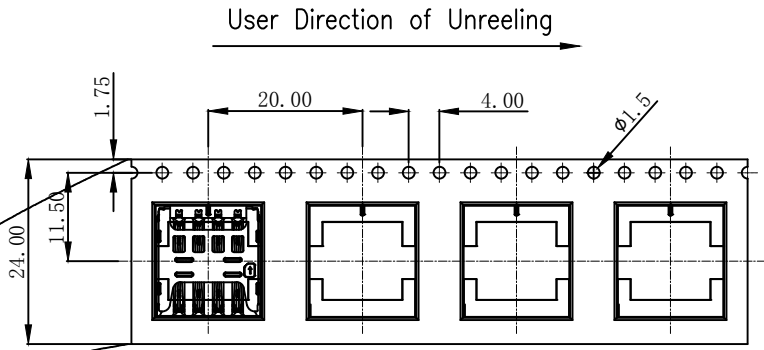


PIN No.	DESCRIPTION
C1	VCC (SUPPLY VOLTAGE)
C2	RST (RESET SIGNAL)
C3	CLK (CLOCK SIGNAL)
C4	RESERVED
C5	GND
C6	VPP (VARIABLE SUPPLY VOLTAGE)
C7	I/O (DATA INPUT/OUTPUT)
C8	RESERVED
G1~G4	GND

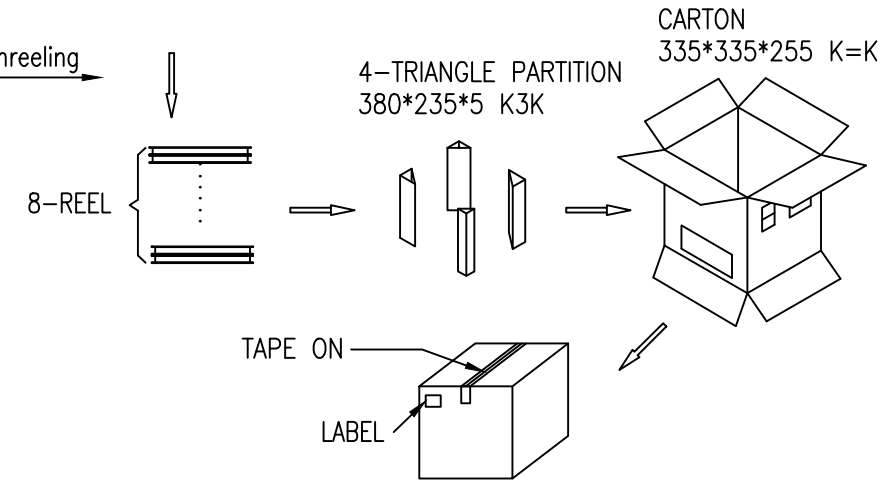
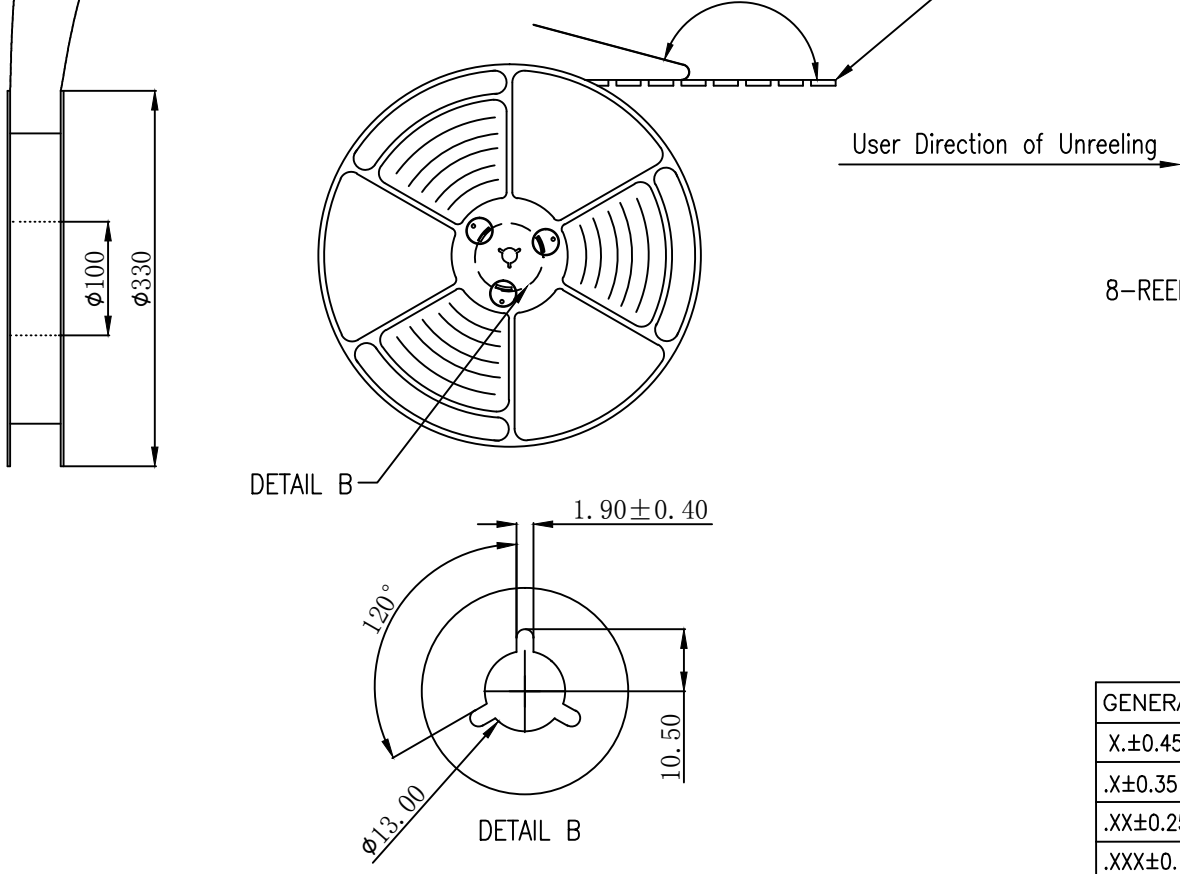
4	TERMINAL 2	4PCS	C5210R	CONTACT:1u"Au;solder:1u"Au;60u"NI PLATING
3	COVER	1PCS	SUS304	solder:1u"Au;30u"NI PLATING
2	TERMINAL 1	4PCS	C5210R	CONTACT:1u"Au;solder:1u"Au;60u"NI PLATING
1	HOUSING	1PCS	LCP	BLACK
NO.	PART NAME	QUANTITY	MATERIAL	COLOR/PLATING

GENERAL TOLERANCE		DWG NO.			APPD:	WIND	Scale	1:1
X.±0.45	x.°±5°	Title	8PIN MICRO SIM CARD H1.50 (防潰PIN)		CHKD:		UNIT	mm
.X±0.35	.x°±2°				DR:			
.XX±0.25	.xx°±1°	Part NO.	5001B-SIM150-107		Date	2014/03/29		
.XXX±0.15	.xxx°±0.5°		东莞市文章济美电子有限公司					
SHEET	1/1							

REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2014/03/29



- NOTES
1. NUMBER OF CONNECTORS:1300PCS/REEL
 2. LEAD TAPE LENGTH
 3. QUANTITY: 10400PCS/CARTON
 4. WEIGHT :
 - 3.1 NET WEIGHT : 3.33Kg
 - 3.2 GROSS WEIGHT : 6.55Kg



GENERAL TOLERANCE		DWG NO.	APPD:	WIND	Scale	1:1
X. $\pm$ 0.45	x. $\pm$ 5°	Title	CHKD:		UNIT	mm
.X $\pm$ 0.35	.x' $\pm$ 2°		DR:			
.XX $\pm$ 0.25	.xx' $\pm$ 1°	Part NO.	Date	2014/03/29		
.XXX $\pm$ 0.15	.xxx' $\pm$ 0.5°					
SHEET	1/1					

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